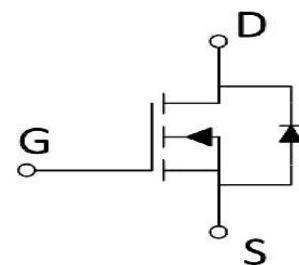
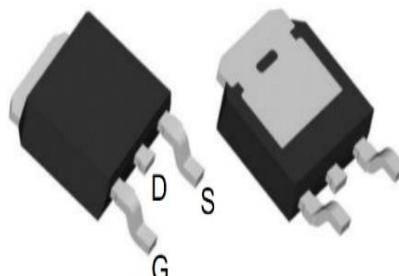


30V_{DS}/±20V_{GS} N-Channel Enhancement Mode MOSFET

Features

- V_{DS}=30V, I_D=50A
- R_{DS(ON)}=12mΩ (TYP.) V_{GS}=10V
- Reliable and Rugged
- Avalanche Rated
- Low On-Resistance
- High Current Capability

TO-252



Applications

- Load Switch
- Power management in portable/desktop PCs
- DC/DC conversion

Ordering Information

Device	Package	Marking	Package Qty.
JMSL0315AK	TO-252	Pb-Free SL0315AK	2500pcs/Reel

Absolute Maximum Ratings (T_C=25°C,unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (V _{GS} =0V)	V _{DS}	30	V
Gate-Source Voltage (V _{GS} =0V,static)	V _{GS}	±20	V
Continuous Drain Current (T _C =25°C)	I _D	50	A
Continuous Drain Current (T _C =100°C)		30	A
Pulses Drain Current	I _{DM}	200	A
Maximum Power Dissipation	P _D	60	W
Single pulse avalanche energy	E _{AS}	100	mJ
Operating,Storage Temperature Range	T _J ,T _{STG}	-55~175	°C

Electrical Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	30	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V	-	-	1	μA
Gate -Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =250μA	1.0	1.6	2.6	V
Drain-SourceOn-stageResistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	9	13	mΩ
		V _{GS} =4.5V, I _D =20A	-	10	16	

Thermal Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal Resistance,Junction-to-Case	$R_{\theta JC}$	-	4.5	-	°C / W
Thermal Resistance,Junction-to-Ambient	$R_{\theta JA}$	-	48	-	°C / W

Dynamic Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Input capacitance	C_{iss}	$V_{DS}=15V$ $V_{GS}=0V$ $f=1MHz$	-	2000	-	pF
Output capacitance	C_{oss}		-	280	-	
Reverse transfer capacitance	C_{rss}		-	210	-	
Gate Resistance	R_g	$f=1MHz$	-	1.5	-	Ω
Total Gate Charge	Q_g		-	32	-	nC
Gate Source Charge	Q_{gs}		-	4.9	-	
Gate Drain Charge	Q_{gd}	$I_D=20A$	-	6.8	-	
Turn-on delay Time	$t_{d(on)}$	$V_{GS}=10V$ $V_{DS}=15V$ $R_L=0.75Ω$ $R_G=3Ω$	-	10	-	ns
Rise time	t_r		-	8	-	
Turn-off delay Time	$t_{d(off)}$		-	25	-	
Fall time	t_f		-	5	-	

Reverse Diode Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Body Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_{SD}=1A$	-	0.85	1.2	V
Reverse Recovery Time	t_{rr}	$V_{GS}=0V, I_{SD}=20A$	-	27	-	ns
Reverse Recovery Charge	Q_{rr}		-	20	-	nC

Electrical Characteristics Diagrams

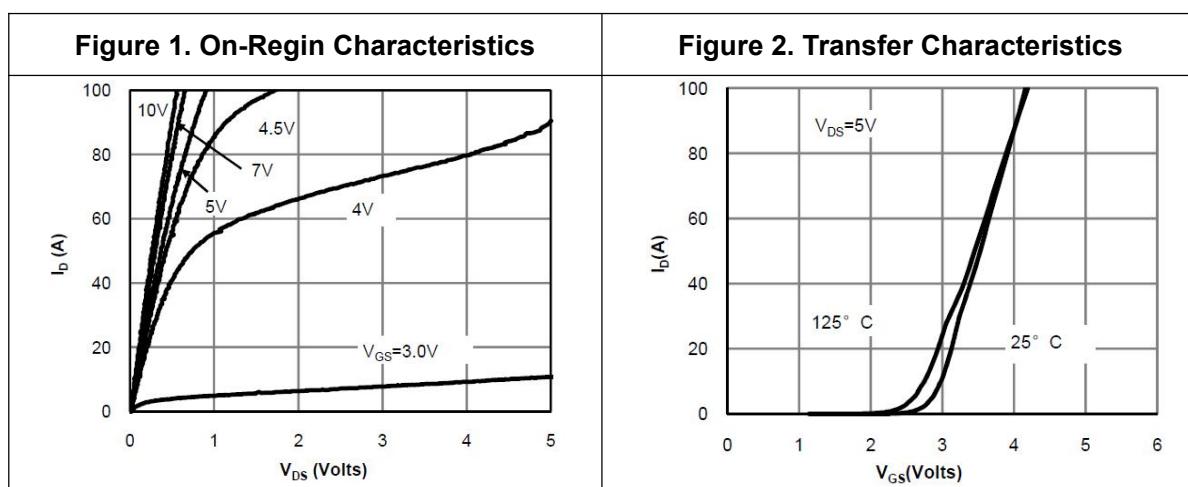


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

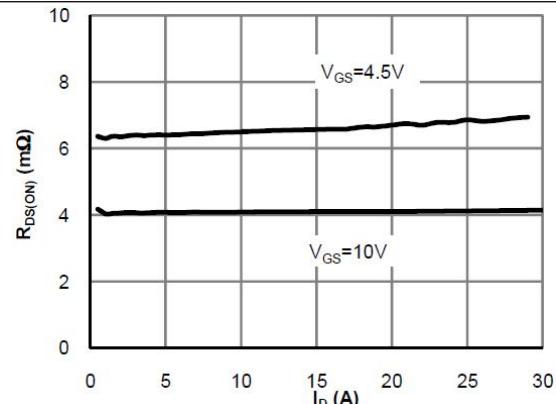


Figure 4. On-Resistance vs. Junction Temperature

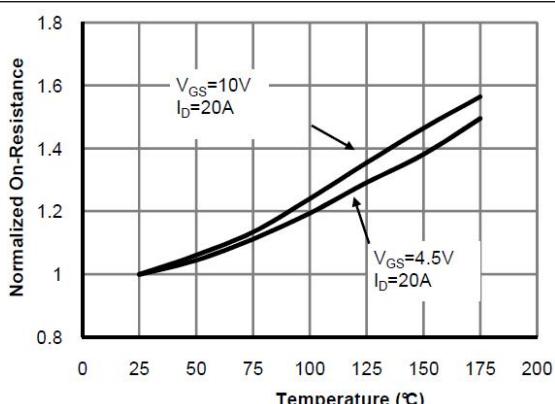


Figure 5. On-Resistance vs. Gate-Source Voltage

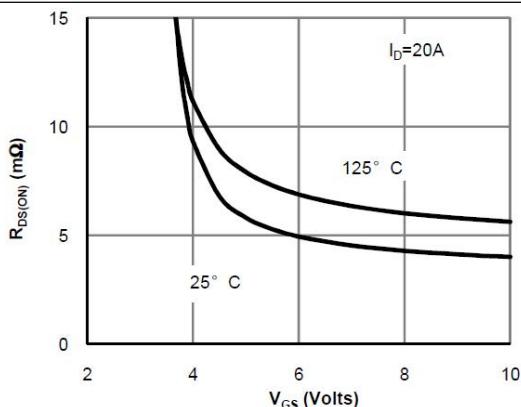


Figure 6. Body-Diode Characteristics

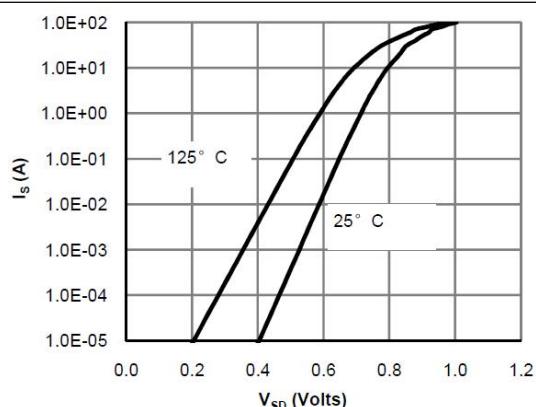


Figure 7. Gate-Charge Characteristics

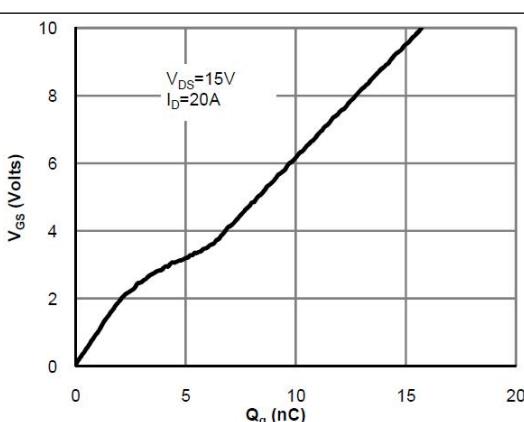


Figure 8. Capacitance Characteristics

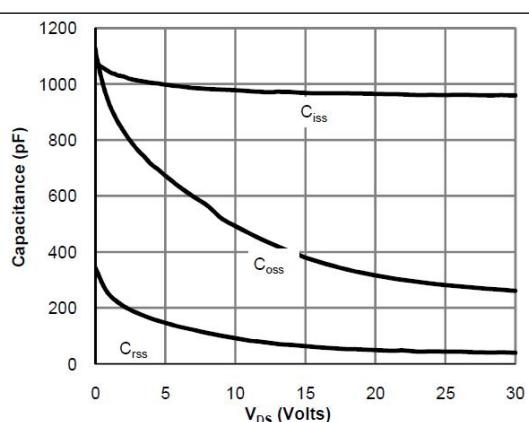


Figure 9. Maximum Forward Biased Safe Operating Area

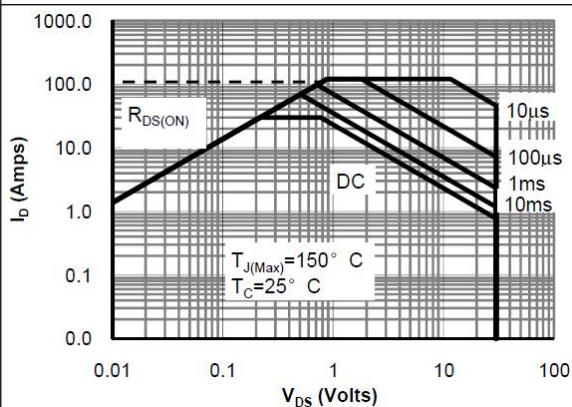


Figure 10. Single Pulse Power Rating Junction-to-Case

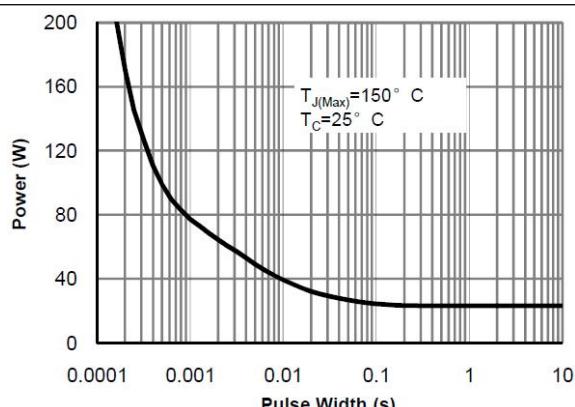
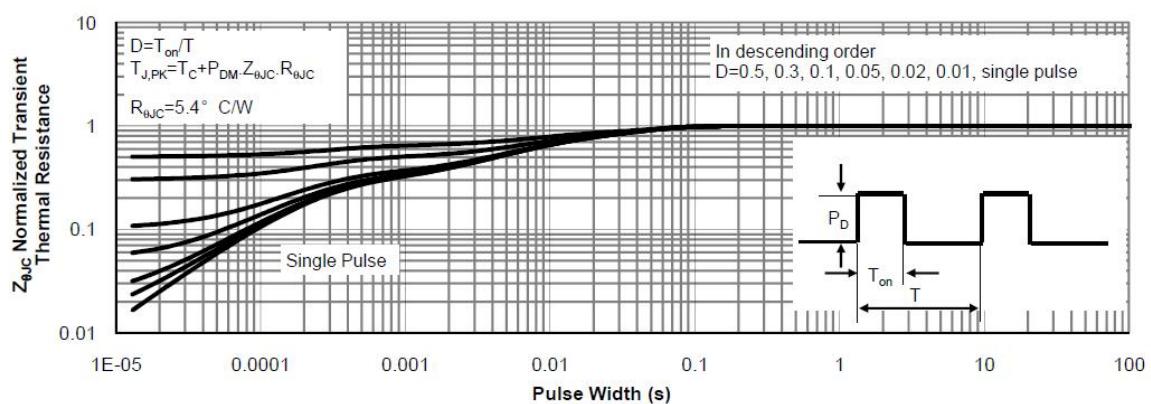


Figure 11. Normalized Maximum Transient Thermal Impedance



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